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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/955,388	09/17/2001	Yoo-Sang Hwang	9898-189	9987	
75	590 05/07/2003				
MARGER JOHNSON & McCOLLOM, P.C.			EXAMINER		
1030 S.W. Mor Portland, OR			MAI, ANH D		
			ART UNIT	PAPER NUMBER	
			2814		
			DATE MAILED: 05/07/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		09/955,388	HWANG ET AL.			
		Examiner	Art Unit			
		Anh D. Mai	2814			
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status	Personaliza to communication(s) filed on 14 A	Anril 2003				
1)⊠	Responsive to communication(s) filed on 14 A	is action is non-final.				
2a)☐	,—		resecution as to the merits is			
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims						
4)⊠ Claim(s) 1-5 and 7-15 is/are pending in the application.						
4a) Of the above claim(s) 1-4 is/are withdrawn from consideration.						
·						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>5 and 7-15</u> is/are rejected. 7)□ Claim(s) is/are objected to.						
	Claim(s) are subject to restriction and/o	r election requirement				
-	on Papers	r oleodon roquiromonia				
9) ☐ The specification is objected to by the Examiner.						
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
	1. Certified copies of the priority document	s have been received.				
	2. Certified copies of the priority document		tion No			
 Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
· · · · · · · · · · · · · · · · · · ·						
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 						
Attachment(s)						
2) Notice	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s) 9	5) Notice of Information	ry (PTO-413) Paper No(s) I Patent Application (PTO-152)			
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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on April 14, 2003 has been entered.

Amendment

2. Amendment filed April 14, 2003 has been entered as Paper No. 11. Claim 5 has been amended. Claim 6 has been cancelled. Claims 1-5 and 7-15 are pending. Claims 1-4 have been withdrawn.

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

3. Claims 8, 14 and 15 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claims 8, 14 and 15 are rejected as being incomplete because these claims dependent on a cancelled claim 6. See MPEP § 608.01(n). Accordingly, the claims 8, 14 and 15 have not been further treated on the merits.

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Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 5, 7, 9-13 are rejected under 35 U.S.C. 102(b) as being anticipated by Omura (U.S. Patent No. 6,028,362).

With respect to claim 5, Omura teaches a method for manufacturing a semiconductor device as claimed including:

forming an insulating layer (44) having a contact hole (44s) therethrough on a semiconductor substrate (40);

forming a diffusion barrier layer (50) on a surface of insulating layer (44) and on surfaces within the contact hole (44s);

forming a first metal layer (52) on the insulating layer (44) having a contact hole (44s) therethrough, the first metal layer (52) having a void (Q) therein below the top surface of the insulating layer (44);

etching back the first metal layer (52) to the depth of the void (Q) to form a first sub-plug (52s) without the void in a lower portion of the contact hole (44s); and

forming a second sub-plug (54) that fills an upper portion of the contact hole (44s) on the first sub-plug (52s). (See Figs. 7-11, col. 1-20).

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With respect to claim 7, the formation of the second sub-plug (54) of Omura comprises forming a second metal layer (54) on the semiconductor substrate (40) on which the first sub-plug (52s) has been formed and polishing the second metal layer (54) so as to expose a top surface of the diffusion barrier layer (50) on the insulating layer (44).

With respect to claim 9, the first sub-plug (52) of Omura is formed of tungsten (W).

With respect to claim 10, the second sub-plug (54) of Omura is formed of a material as claimed.

With respect to claim 11, the second sub-plug (54) of Omura is formed to a thickness as claimed, no greater than 1000 Å.

With respect to claim 12, the diffusion barrier layer (50) of Omura is formed of a material as claimed.

With respect to claim 13, the plug formed in the contact hole (44s) contacts the surface of the semiconductor substrate (40).

Response to Arguments

5. Applicant's arguments with respect to all claims have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anh D. Mai whose telephone number is (703) 305-0575. The examiner can normally be reached on 8:30AM-5:00PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (703) 308-4918. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

A.MMay 1, 2003

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